280610-1 🗸 ACTIVE

AMPMODU | AMPMODU MOD 1

TE Internal #: 280610-1 PCB Mount Header, Vertical, Board-to-Board, 4 Position, 3.96 mm [. 156 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU MOD 1

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 4

Number of Rows: 1

Features

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Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Partially Shrouded
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	4
Number of Rows	1
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Dielectric Withstanding Voltage (Max)	750 VACrms
Body Features	
Connector Profile	Standard

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Primary Product Color	Green
Contact Features	
Contact Mating Area Length	10 mm[.393 in]
Mating Tab Width	1.6 mm[.063 in]
Mating Tab Thickness	.79 mm[.031 in]
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Brass
Contact Mating Area Plating Material	Tin
Contact Mating Area Plating Material Thickness	.38 μm[15 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.8 mm[.031 in]
Rectangular Termination Post & Tail Width	.9 mm[.035 in]
Termination Post & Tail Length	3.3 mm
Termination Method to Printed Circuit Board	Through Hole - Solder

Mechanical Attachment

Mating Alignment	With
Mating Alignment Type	Polarization
PCB Mount Retention	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	3.96 mm[.156 in]
Housing Material	Polycarbonate GF
Usage Conditions	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Approved Standards	CSA LR7189, UL E28476

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Packaging Features

Packaging Quantity	500
Packaging Type	Carton

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) SVHC > Threshold: Perfluorobutane sulfonic acid (PFBS) and its salts (.16% in Component Part) Aticle Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR /CFR/PVC Free
Solder Process Canability	Wave solder capable to 265° C

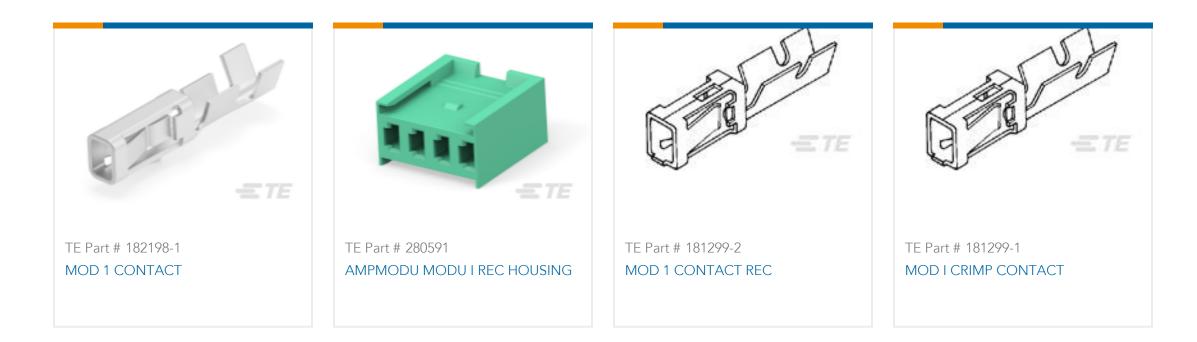
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

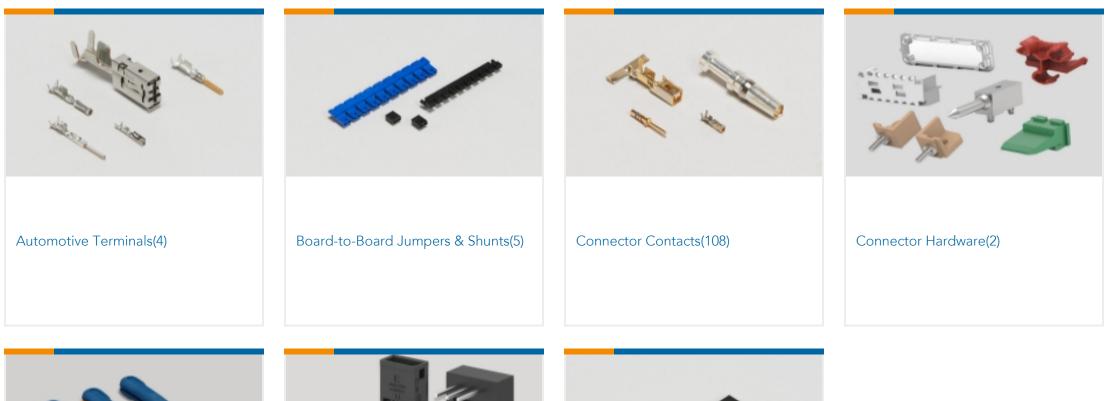
Compatible Parts

PCB Mount Header, Vertical, Board-to-Board, 4 Position, 3.96 mm [.156 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU MOD 1





Also in the Series AMPMODU MOD 1





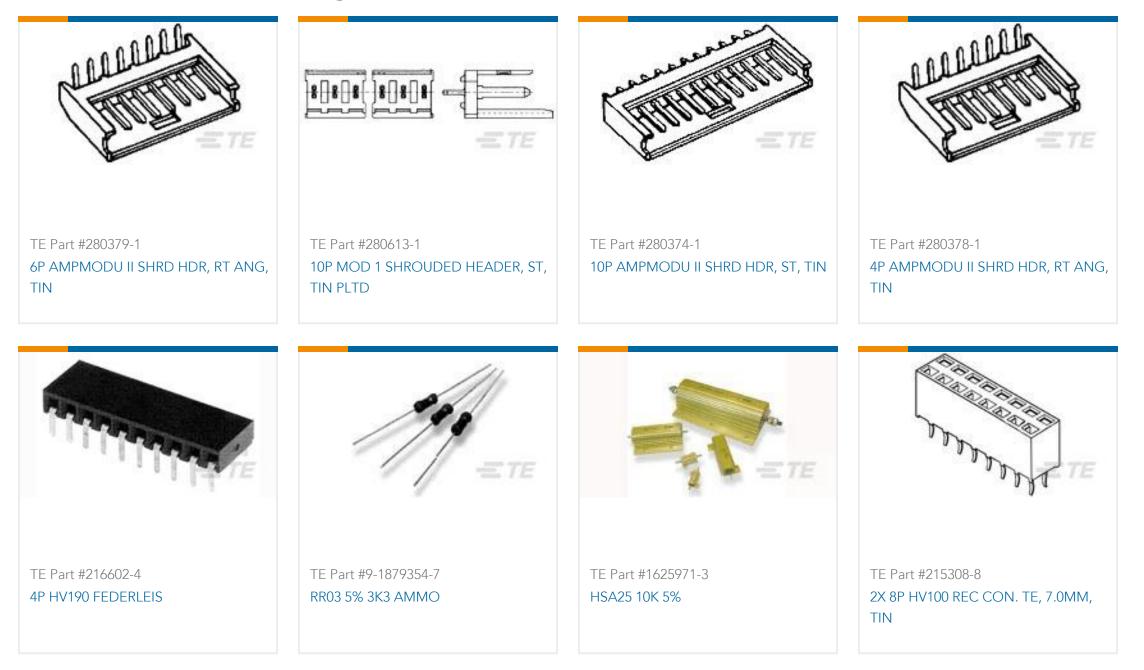




PCB Headers & Receptacles(341)

Wire-to-Board Connector Assemblies & Housings(32)

Customers Also Bought



PCB Mount Header, Vertical, Board-to-Board, 4 Position, 3.96 mm [.156 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU MOD 1





Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_280610-1_M_c-280610-1-m.2d_dxf.zip

English

Customer View Model ENG_CVM_CVM_280610-1_M_c-280610-1-m.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_280610-1_M_c-280610-1-m.3d_stp.zip

English

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Product Environmental Compliance

Product Compliance Document

English

Product Compliance Document

English

Agency Approvals UL Report

English